PT380/PT380F PT381/PT381F

High Sensitivity, ϕ 3mm Resin Mold Type Phototransistor

■ Features

1. High sensitivity

(I_C : MIN.160 μ A at $E_{\rm \,V}$ = 1001x, $\,$ PT380) (I_C : MIN.120 μ A at $E_{\rm \,V}$ = 21x, $\,$ PT381)

2. Compact \$\phi\$3mm resin mold package

3. Intermediate acceptance ($\Delta\theta$: TYP. \pm 20°) 4. Visible light cut-off type : **PT380F/PT381F**

■ Model Line-ups

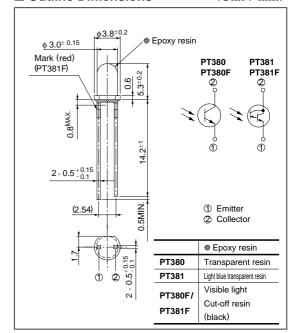
	Single photo- transistor output	Darlington photo- transistor output
No visible light cut-off filter	PT380	PT381
Built-in visible light cut-off filter	PT380F	PT381F

■ Applications

- 1. Floppy disk drives
- 2. Optoelectronic switches
- 3. Infrared applied systems

■ Outline Dimensions

(Unit: mm)



■ Absolute Maximum Ratings

 $(Ta = 25^{\circ}C)$

Parameter	Symbol	Rating	Unit	
Collector-emitter voltage	V _{CEO}	35	V	
Emitter-collector voltage	V ECO	6	V	
Collector current	$I_{\rm C}$	20	mA	
Collector power dissipation	Pc	50	mW	
Operating temperature	T opr	- 25 to +85	°C	
Storage temperature	T stg	- 40 to +85	°C	
*1 Soldering temperature	T sol	260	°C	

^{*1} For 3 seconds at the position of 1.4mm from the bottom face of resin package

■ Electro-optical Characteristics

 $(Ta = 25^{\circ}C)$

Parameter		Symbol	Conditions	MIN.	TYP.	MAX.	Unit	
*2Collector current		PT380	I _C	$E_V = 100l_X$	0.16	-	1.17	mA
		PT380F		$V_{CE} = 5V$	0.095	-	0.90	
		PT381		$E_V = 2l_X$	0.12	-	1.5	
		PT381F		$V_{CE} = 10V$	0.07	-	1.08	
		PT380/PT380F	I _{CEO}	$E_e = 0$, $V_{CE} = 20V$	-	-	0.1	μА
		PT381 / PT381F		$E_e = 0, V_{CE} = 10V$	-	-	1.0	
*2Collector-	emitter	PT380/PT380F	37	$E_e = 10 \text{mW/cm}^2$, $I_C = 0.5 \text{mA}$	-	0.2	0.4	X 7
saturation voltage		PT381 / PT381F	V _{CE(sat)}	$E_e = 1 \text{mW/cm}^2$, $I_C = 2.5 \text{mA}$	-	-	1.0	V
Collector	Collector-emitter breakdown		BV CEO	$I_C = 0.1 \text{mA}$	35			
voltage	voltage			$E_e = 0$		-	-	V
Emitter-0	Emitter-Collector breakdown		BV _{ECO}	$I_C = 0.01 \text{mA}$	6		-	V
voltage	voltage			$E_e = 0$	0	-		
Peak sensitivity wavelength		PT380/PT381	2	-	-	800	-	nm
		PT380F/PT381F	λ _P		-	860	-	
Response	Rise time	PT380/PT380F	t _r	$V_{CE} = 20V$, $I_{C} = 1mA$, $R_{L} = 1k\Omega$	-	10	40	μs
		PT381 / PT381F		$V_{CE} = 2V, I_C = 10mA, R_L = 100\Omega$	-	100	400	
	Fall time	PT380 / PT380F	t _f	$V_{CE} = 20V$, $I_C = 1mA$, $R_L = 1k\Omega$	-	8	35	
	ran tille	PT381 / PT381F		$V_{CE} = 2V, I_{C} = 10mA, R_{L} = 100\Omega$	-	100	400	
Half inte	Half intensity angle		Δθ		-	± 20	-	٥

^{*2} E_V, E_e: Illuminance, irradiance by CIE standard light source A (tungsten lamp)

Fig. 1 Collector Power Dissipation vs.
Ambient Temperature

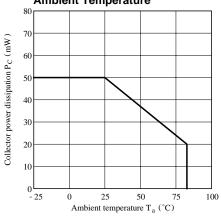


Fig. 2-a Collector Dark Current vs.
Ambient Temperature

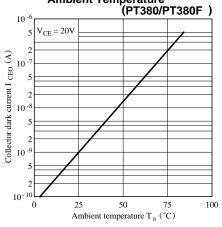


Fig. 2-b Collector Dark Current vs.
Ambient Temperature

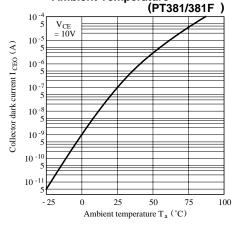


Fig. 3-b Relative Collector Current vs. Ambient Temperature

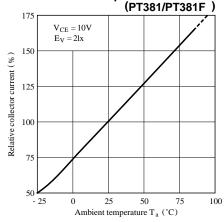


Fig. 4-b Collector Current vs.
Irradiance (PT381/PT381F)

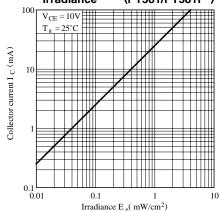


Fig. 3-a Relative Collector Current vs.

Ambient Temperature

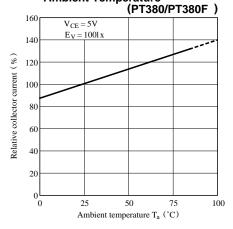


Fig. 4-a Collector Current vs.

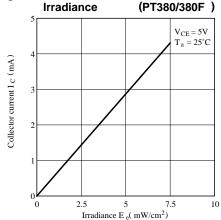


Fig. 5-a Collector Current vs.
Collector-emitter Voltage
(PT380/380F)

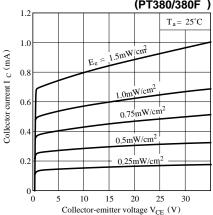


Fig. 5-b Collector Current vs.
Collector-emitter Voltage
(PT381/381F)

 $T_a = 25^{\circ}C$ P_C(MAX) 25 Collector current I c (mA) $E_e = 1.0 \text{mW/cm}^2$ 20 0.75mW/cm² 15 0.5mW/cm^2 10 0.25mW/cm2 0.1mW/cm^2 1 2 3 4 5 6 8 10 0 Collector-emitter voltage V_{CE} (V)

Fig. 7-a Response Time vs. Load Resistance (PT380/PT380F)

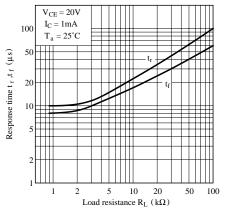


Fig. 7-b Response Time vs. Load Resistance (PT381/381F)

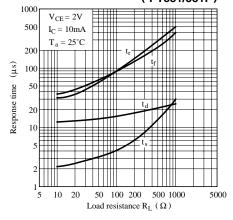
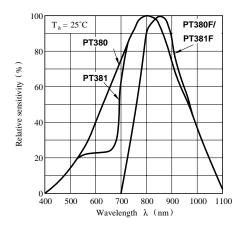
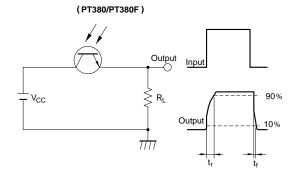


Fig. 6 Spectral Sensitivity



Test Circuit for Response Time



Test Circuit for Response Time

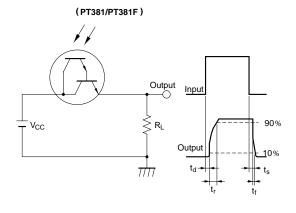


Fig. 8-a Collector-emitter Saturation Voltage vs. Irradiance

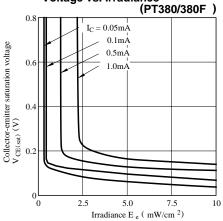
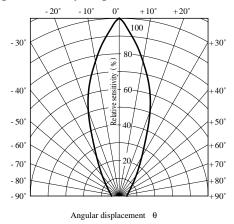


Fig. 9 Sensitivity Diagram





Please refer to the chapter "Precautions for Use."

Fig. 8-b Collector-emitter Saturation Voltage vs. Irradiance

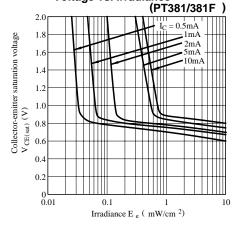
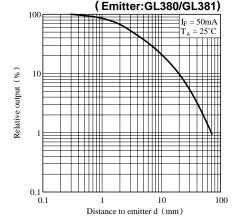


Fig.10 Relative Collector Current vs. Distance to Emitter



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